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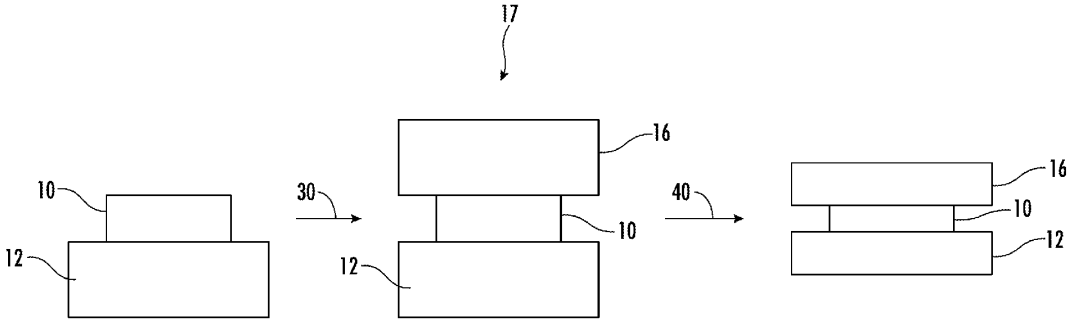


FIG. 1

(57) Abstract: A conductive paste is provided. The conductive paste includes a metal particulate material having a first metal powder having a having a D50 ranging from about 500 nm to about 1,500 nm, a second metal powder having a D50 ranging from about 10 nm to about 100 nm, and a third metal powder having a D50 ranging from about 3,000 nm to about 5,500 nm. The metal paste includes a solvent composition. The weight ratio of the third metal powder to the first metal powder is greater than 1. Electronic articles are also provided.

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